

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10594907
<b>Filing Date:</b>	07-Aug-2008
<b>Title of Invention:</b>	LASER PROCESSING METHOD FOR CUTTING SUBSTRATE AND LAMINATE PART BONDED TO THE SUBSTRATE
<b>First Named Inventor/Applicant Name:</b>	Takeshi Sakamoto
<b>Filer:</b>	John G. Smith/Traci Thompson
<b>Attorney Docket Number:</b>	46884-5519 (232060)

Filed as Large Entity

### U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 4 months with \$0 paid	1254	1	1730	1730

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				2540